## **EAST Search History**

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	176	(silicon near2 substrate) and (LED with package) and @pd<"20040222"	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 15:30
L4	855	("257"/\$.ccls. or "438"/\$.ccls.) and (LED) and (power with (w or watt))and @pd<"20040222"	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 15:32
L5	48	("257"/\$.ccls. or "438"/\$.ccls.) and (LED.clm.) and (power with (w or watt))and @pd<"20040222"	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 15:32
L6	2147	257/99,e33.056.ccls.	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 16:32
L7	292	(amoh-teruo or ishidu-sadamu or higaki-kenjiro or tsuzuki-yasushi or fukuda-hiroshi).inv.	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 16:33
L8	5335	(SUMITOMO ELECTRIC INDUSTRIES).as.	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 16:34
L9	576	8 and packag\$3	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 16:34
L10	35	7 and packag\$3	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 16:34
L11	595	9 or 10	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 16:35
S1	38585	(physical vapor deposition) or pvd	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 09:20
S2	12598	((physical vapor deposition) or pvd) and (imager or LED or laser)	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 09:20
S3	7557	((physical vapor deposition) or pvd) and (imager or LED or laser) and rate	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 09:25
S4	39485	((physical vapor deposition) or pvd or (vacuum vapor deposition) or vvd or sputter or sputtering) and (imager or LED or laser) and rate	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 09:27
S5	36632	S4 and (aluminum or al)	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 09:26

## **EAST Search History**

S6	7183	((physical vapor deposition) or pvd or (vacuum vapor deposition) or vvd or sputter or sputtering) and (imager or LED or laser) and rate and ("438"/\$).ccls.	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 09:28
S8	133	S7 and ((sputter\$3 near3 rate) or (arrival near2 rate) or (deposit near3 rate))	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 09:32
S9	3559	((physical vapor deposition) or pvd or (vacuum vapor deposition) or vvd or sputter or sputtering) and (imager or LED or laser) and rate and ("438"/\$).ccls. and @pd<"20040222"	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 10:01
S10	9687	((physical vapor deposition) or pvd or (vacuum vapor deposition) or vvd or sputter or sputtering) and roughness and @pd<"20040222"	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 15:22
S11	7788	((physical vapor deposition) or pvd or (vacuum vapor deposition) or vvd or sputter or sputtering) and (roughness near2 surface) and @pd<"20040222"	US-PGPUB; USPAT; IBM_TDB	ADJ	OFF	2008/01/04 10:10
S12	4	"2004111616".pn.	JPO; DERWENT	ADJ	OFF	2008/01/04 10:13
S13	1	"6017226".pn.	JPO; DERWENT	ADJ	OFF	2008/01/04 10:13
S14	2	"06017226".pn.	JPO; DERWENT	ADJ	OFF	2008/01/04 10:16
S15	2	"07243027".pn.	JPO; DERWENT	ADJ	OFF	2008/01/04 10:18
S16	3	"2003209286".pn.	JPO; DERWENT	ADJ	OFF	2008/01/04 10:22
S17	4	"2004079750".pn.	JPO; DERWENT	ADJ	OFF	2008/01/04 10:25
S18	4	"2004071675".pn.	JPO; DERWENT	ADJ	OFF	2008/01/04 10:28
S19	4	"2005039194".pn.	JPO; DERWENT	ADJ	OFF	2008/01/04 10:32
S20	2	"09293904".pn.	JPO; DERWENT	ADJ	OFF	2008/01/04 10:33
S21	1	"6777720".pn.	US-PGPUB; USPAT	ADJ	OFF	2008/01/04 10:36
S22	3	"2002232017".pn.	JPO; DERWENT	ADJ	OFF	2008/01/04 10:37